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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	4224
Number of Logic Elements/Cells	-
Total RAM Bits	55296
Number of I/O	115
Number of Gates	250000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/microsemi/ax250-pqg208

User I/Os[2]

Introduction

The Axcelerator family features a flexible I/O structure, supporting a range of mixed voltages (1.5 V, 1.8 V, 2.5 V, and 3.3 V) with its bank-selectable I/Os. Table 2-8 on page 2-12 contains the I/O standards supported by the Axcelerator family, and Table 2-10 on page 2-12 compares the features of the different I/O standards.

Each I/O provides programmable slew rates, drive strengths, and weak pull-up and weak pull-down circuits. The slew rate setting is effective for both rising and falling edges.

I/O standards, except 3.3 V PCI and 3.3 V PCI-X, are capable of hot insertion. 3.3 V PCI and 3.3 V PCI-X are 5 V tolerant with the aid of an external resistor.

The input buffer has an optional user-configurable delay element. The element can reduce or eliminate the hold time requirement for input signals registered within the I/O cell. The value for the delay is set on a bank-wide basis. Note that the delay WILL be a function of process variations as well as temperature and voltage changes.

Each I/O includes three registers: an input (InReg), an output (OutReg), and an enable register (EnReg). I/Os are organized into banks, and there are eight banks per device—two per side (Figure 2-6 on page 2-18). Each I/O bank has a common VCCI, the supply voltage for its I/Os.

For voltage-referenced I/Os, each bank also has a common reference-voltage bus, VREF. While VREF must have a common voltage for an entire I/O bank, its location is user-selectable. In other words, any user I/O in the bank can be selected to be a VREF.

The location of the VREF pin should be selected according to the following rules:

- Any pin that is assigned as a VREF can control a maximum of eight user I/O pad locations in each direction (16 total maximum) within the same I/O bank.
- I/O pad locations listed as no connects are counted as part of the 16 maximum. In many cases, this leads to fewer than eight user I/O package pins in each direction being controlled by a VREF pin.
- Dedicated I/O pins such as GND and VCCI are counted as part of the 16.
- The two user I/O pads immediately adjacent on each side of the VREF pin (four in total) may only be used as inputs. The exception is when there is a VCCI/GND pair separating the VREF pin and the user I/O pad location.
- The user does not need to assign VREF pins for OUTBUF and TRIBUF. VREF pins are needed only for input and bidirectional I/Os.

The differential amplifier supply voltage VCCDA should be connected to 3.3 V.

A user can gain access to the various I/O standards in three ways:

- Instantiate specific library macros that represent the desired specific standard.
- Use generic I/O macros and then use Designer's PinEditor to specify the desired I/O standards (please note that this is not applicable to differential standards).
- A combination of the first two methods.

Refer to the *I/O Features in Axcelerator Family Devices* application note and the *Antifuse Macro Library Guide* for more details.

2. *Do not use an external resister to pull the I/O above V_{CCI} for a higher logic "1" voltage level. The desired higher logic "1" voltage level will be degraded due to a small I/O current, which exists when the I/O is pulled up above V_{CCI}.*

I/O Module Timing Characteristics

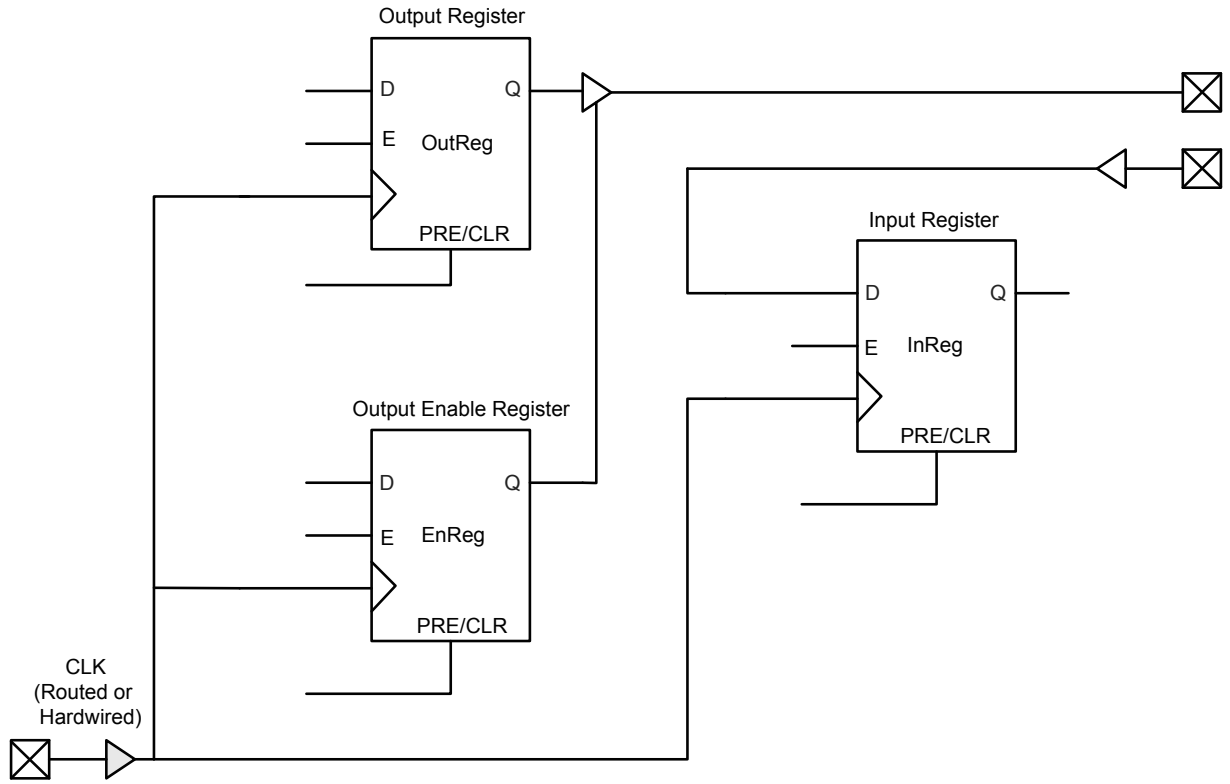


Figure 2-11 • **Timing Model**

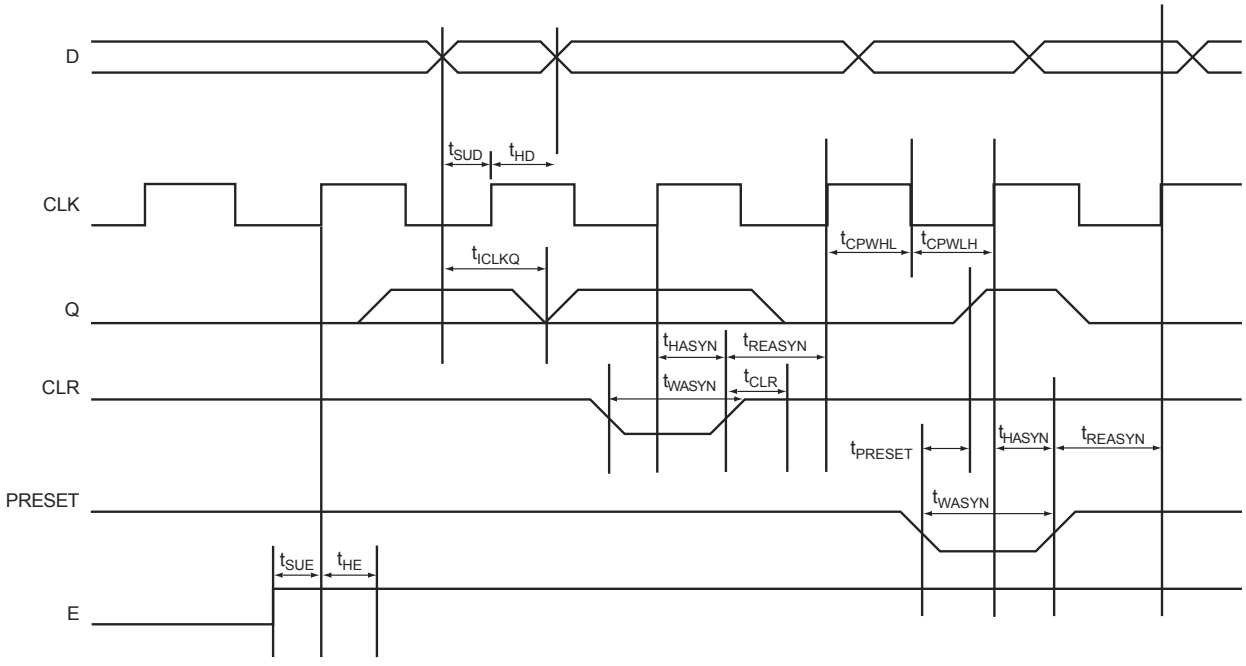


Figure 2-12 • **Input Register Timing Characteristics**

1.5 V LVCMOS (JESD8-11)

Low-Voltage Complementary Metal-Oxide Semiconductor for 1.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.5 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

***Table 2-29* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
–0.3	0.35 VCCI	0.65 VCCI	3.6	0.4	VCCI – 0.4	8 mA	–8 mA

AC Loadings

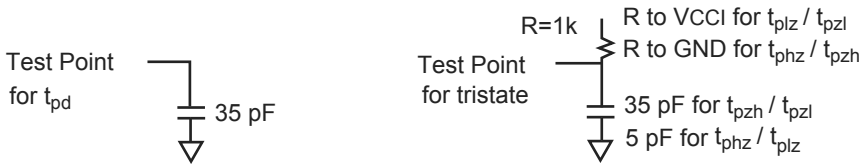


***Table 2-30* • AC Test Loads**

***Table 2-31* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
0	1.5	$0.5V_{CCI}$	N/A	35

*Note: * Measuring Point = VTRIP*

Timing Characteristics

***Table 2-61* • LVPECL I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
LVPECL Output Module Timing								
t_{DP}	Input Buffer		1.66		1.89		2.22	ns
t_{PY}	Output Buffer		2.24		2.55		3.00	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the IO output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Carry-Chain Logic

The Axcelerator dedicated carry-chain logic offers a very compact solution for implementing arithmetic functions without sacrificing performance.

To implement the carry-chain logic, two C-cells in a Cluster are connected together so the FCO (i.e. carry out) for the two bits is generated in a carry look-ahead scheme to achieve minimum propagation delay from the FCI (i.e. carry in) into the two-bit Cluster. The two-bit carry logic is shown in Figure 2-29.

The FCI of one C-cell pair is driven by the FCO of the C-cell pair immediately above it. Similarly, the FCO of one C-cell pair, drives the FCI input of the C-cell pair immediately below it (Figure 1-4 on page 1-3 and Figure 2-30 on page 2-57).

The carry-chain logic is selected via the CFN input. When carry logic is not required, this signal is deasserted to save power. Again, this configuration is handled automatically for the user through Microsemi's macro library.

The signal propagation delay between two C-cells in the carry-chain sequence is 0.1 ns.

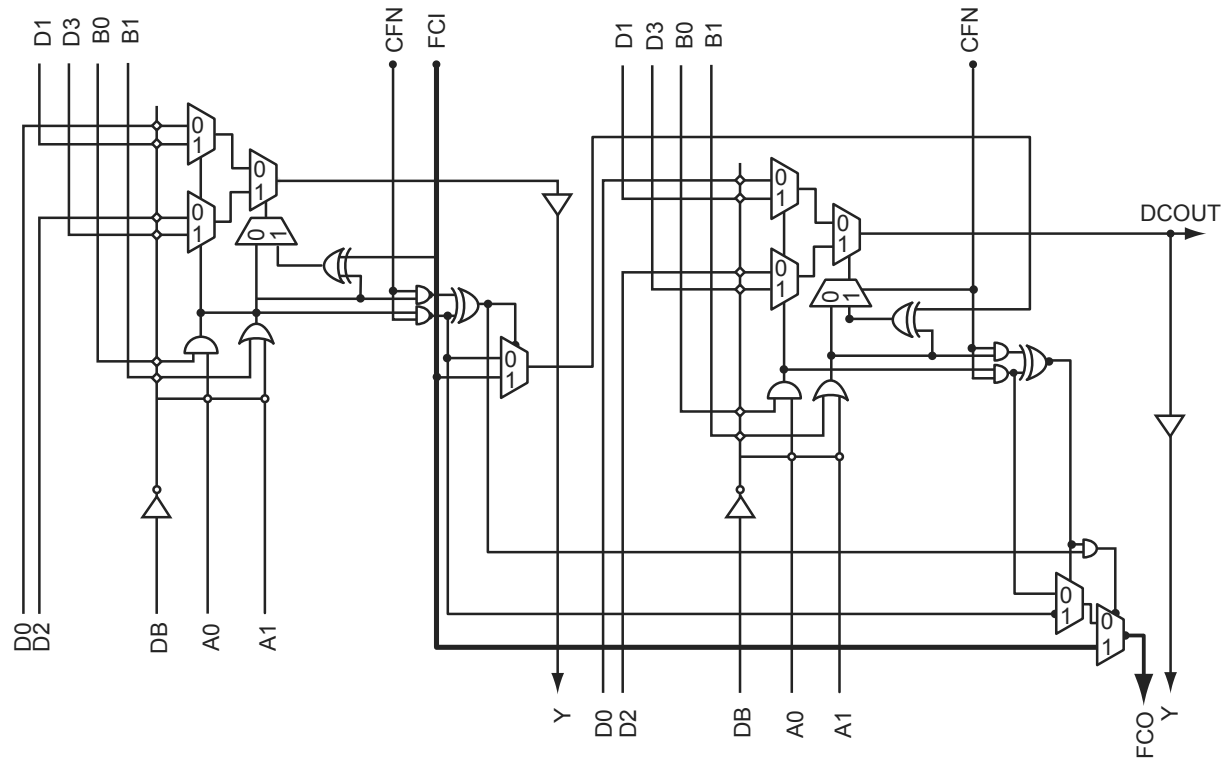


Figure 2-29 • **Axcelerator's Two-Bit Carry Logic**

Routing Specifications

Routing Resources

The routing structure found in Axcelerator devices enables any logic module to be connected to any other logic module while retaining high performance. There are multiple paths and routing resources that can be used to route one logic module to another, both within a SuperCluster and elsewhere on the chip.

There are four primary types of routing within the AX architecture: DirectConnect, CarryConnect, FastConnect, and Vertical and Horizontal Routing.

DirectConnect

DirectConnects provide a high-speed connection between an R-cell and its adjacent C-cell (Figure 2-35). This connection can be made from DCOUT of the C-cell to DCIN of the R-cell by configuring of the S1 line of the R-cell. This provides a connection that does not require an antifuse and has a delay of less than 0.1 ns.

Figure 2-35 • **DirectConnect and CarryConnect**

CarryConnect

CarryConnects are used to build carry chains for arithmetic functions (Figure 2-35). The FCO output of the right C-cell of a two-C-cell Cluster drives the FCI input of the left C-cell in the two-C-cell Cluster immediately below it. This pattern continues down both sides of each SuperCluster column.

Similar to the DirectConnects, CarryConnects can be built without an antifuse connection. This connection has a delay of less than 0.1 ns from the FCO of one two-C-cell cluster to the FCI of the two-C-cell cluster immediately below it (see the "Carry-Chain Logic" section on page 2-56 for more information).

FastConnect

For high-speed routing of logic signals, FastConnects can be used to build a short distance connection using a single antifuse (Figure 2-36 on page 2-62). FastConnects provide a maximum delay of 0.3 ns. The outputs of each logic module connect directly to the Output Tracks within a SuperCluster. Signals on the Output Tracks can then be routed through a single antifuse connection to drive the inputs of logic modules either within one SuperCluster or in the SuperCluster immediately below it.

single-ended, or voltage-referenced standard. The [H]CLKxN pad can only be used as a differential pair with [H]CLKxP.

The block marked “/i Delay Match” is a fixed delay equal to that of the i divider. The “/j Delay Match” block has the same function as its j divider counterpart.

Functional Description

Figure 2-48 on page 2-75 illustrates a block diagram of the PLL. The PLL contains two dividers, i and j, that allow frequency scaling of the clock signal:

- The i divider in the feedback path allows multiplication of the input clock by integer factors ranging from 1 to 64, and the resultant frequency is available at the output of the PLL block.
- The j divider divides the PLL output by integer factors ranging from 1 to 64, and the divided clock is available at CLK1.
- The two dividers together can implement any combination of multiplication and division up to a maximum frequency of 1 GHz on CLK1. Both the CLK1 and CLK2 outputs have a fixed 50/50 duty cycle.
- The output frequencies of the two clocks are given by the following formulas (f_{REF} is the reference clock frequency):

$$f_{CLK1} = f_{REF} * (DividerI) / (DividerJ)$$

EQ 4

$$f_{CLK2} = f_{REF} * (DividerI)$$

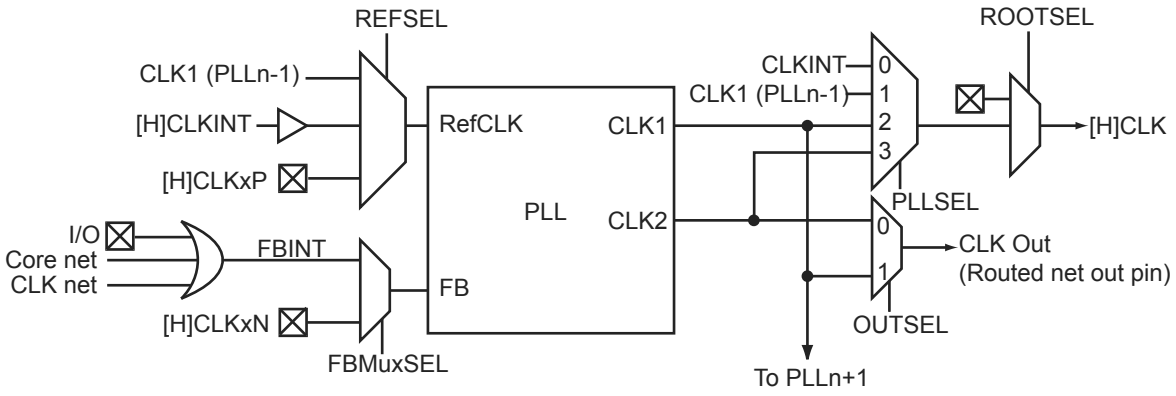
EQ 5

- CLK2 provides the PLL output directly—without division

The input and output frequency ranges are selected by LowFreq and Osc(2:0), respectively. These functions and their possible values are detailed in Table 2-80 on page 2-77.

The delay lines shown in Figure 2-48 on page 2-75 are programmable. The feedback clock path can be delayed (using the five DelayLine bits) relative to the reference clock (or vice versa) by up to 3.75 ns in increments of 250 ps. Table 2-80 on page 2-77 describes the usage of these bits. The delay increments are independent of frequency, so this results in phase changes that vary with frequency. The delay value is highly dependent on V_{CC} and the speed grade.

Figure 2-49 is a logical diagram of the various control signals to the PLL and shows how the PLL interfaces with the global and routing networks of the FPGA. Note that not all signals are user-accessible. These non-user-accessible signals are used by the place-and-route tool to control the configuration of the PLL. The user gains access to these control signals either based upon the connections built in the user's design or through the special macros (Table 2-84 on page 2-81) inserted into the design. For example, connecting the macro PLLOUT to CLK2 will control the OUTSEL signal.



Note: Not all signals are available to the user.

Figure 2-49 • **PLL Logical Interface**

***Table 2-83* • South PLL Connections**

CLK1	CLK2
CLK1	Routed net
CLK1	Unused
CLK2	CLK1
CLK2	Routed net
CLK2	Both CLK1 and routed net
CLK2	Unused
Unused	CLK1
Unused	Routed net
Unused	Both CLK1 and routed net
Unused	Unused
Routed net	CLK1
Routed net	Unused
Both CLK1 and CLK2	Routed net
Both CLK1 and CLK2	Unused
Both CLK1 and routed net	Unusable
Both CLK2 and routed net	CLK1
Both CLK2 and routed net	Unused
CLK1, CLK2, and routed net	Unusable

Note: Designer software currently does not support all of these connections. Only exclusive connections where one output connects to a single net are supported at this time (e.g., CLK1 driving both CLK1 and CLK2 is not supported).

Sample Implementations

Frequency Synthesis

Figure 2-53 illustrates an example where the PLL is used to multiply a 155.5 MHz external clock up to 622 MHz. Note that the same PLL schematic could use an external 350 MHz clock, which is divided down to 155 MHz by the FPGA internal logic.

Figure 2-54 illustrates the PLL using both dividers to synthesize a 133 MHz output clock from a 155 MHz input reference clock. The input frequency of 155 MHz is multiplied by 6 and divided by 7, giving a CLK1 output frequency of 132.86 MHz. When dividers are used, a given ratio can be generated in multiple ways, allowing the user to stay within the operating frequency ranges of the PLL.

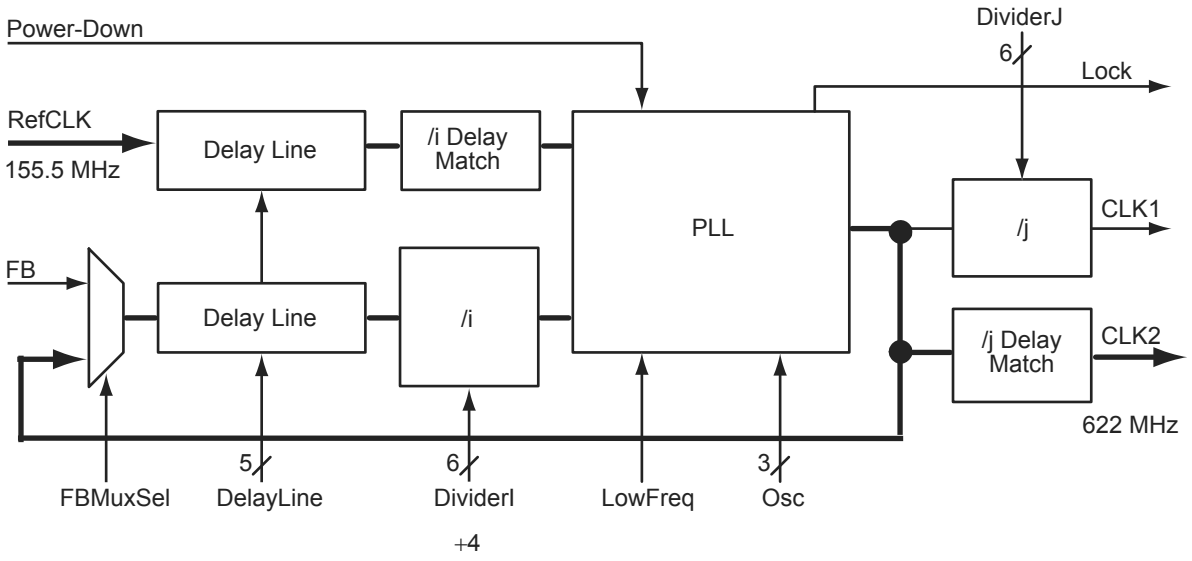


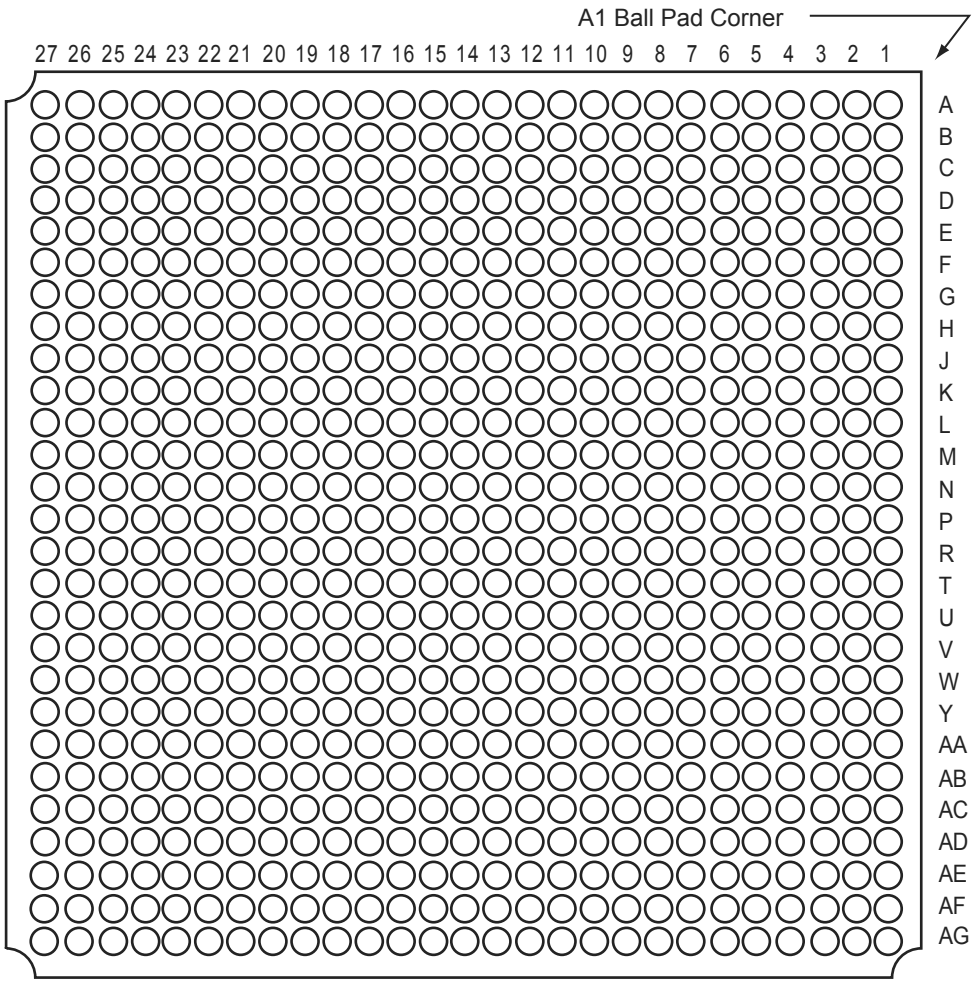
Figure 2-53 • **Using the PLL 155.5 MHz In, 622 MHz Out**

Adjustable Clock Delay

Figure 2-55 illustrates using the PLL to delay the reference clock by employing one of the adjustable delay lines. In this case, the output clock is delayed relative to the reference clock. Delaying the reference clock relative to the output clock is accomplished by using the delay line in the feedback path.

3 – Package Pin Assignments

BG729



Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

BG729	
AX1000 Function	**Pin Number**
VCCIB0	B4
VCCIB0	C4
VCCIB0	J10
VCCIB0	J11
VCCIB0	J12
VCCIB0	K12
VCCIB0	K13
VCCIB1	A24
VCCIB1	B24
VCCIB1	C24
VCCIB1	J16
VCCIB1	J17
VCCIB1	J18
VCCIB1	K15
VCCIB1	K16
VCCIB2	D25
VCCIB2	D26
VCCIB2	D27
VCCIB2	K19
VCCIB2	L19
VCCIB2	M18
VCCIB2	M19
VCCIB2	N18
VCCIB3	AD25
VCCIB3	AD26
VCCIB3	AD27
VCCIB3	R18
VCCIB3	T18
VCCIB3	T19
VCCIB3	U19
VCCIB3	V19
VCCIB4	AE24
VCCIB4	AF24
VCCIB4	AG24
VCCIB4	V15
VCCIB4	V16
VCCIB4	W16

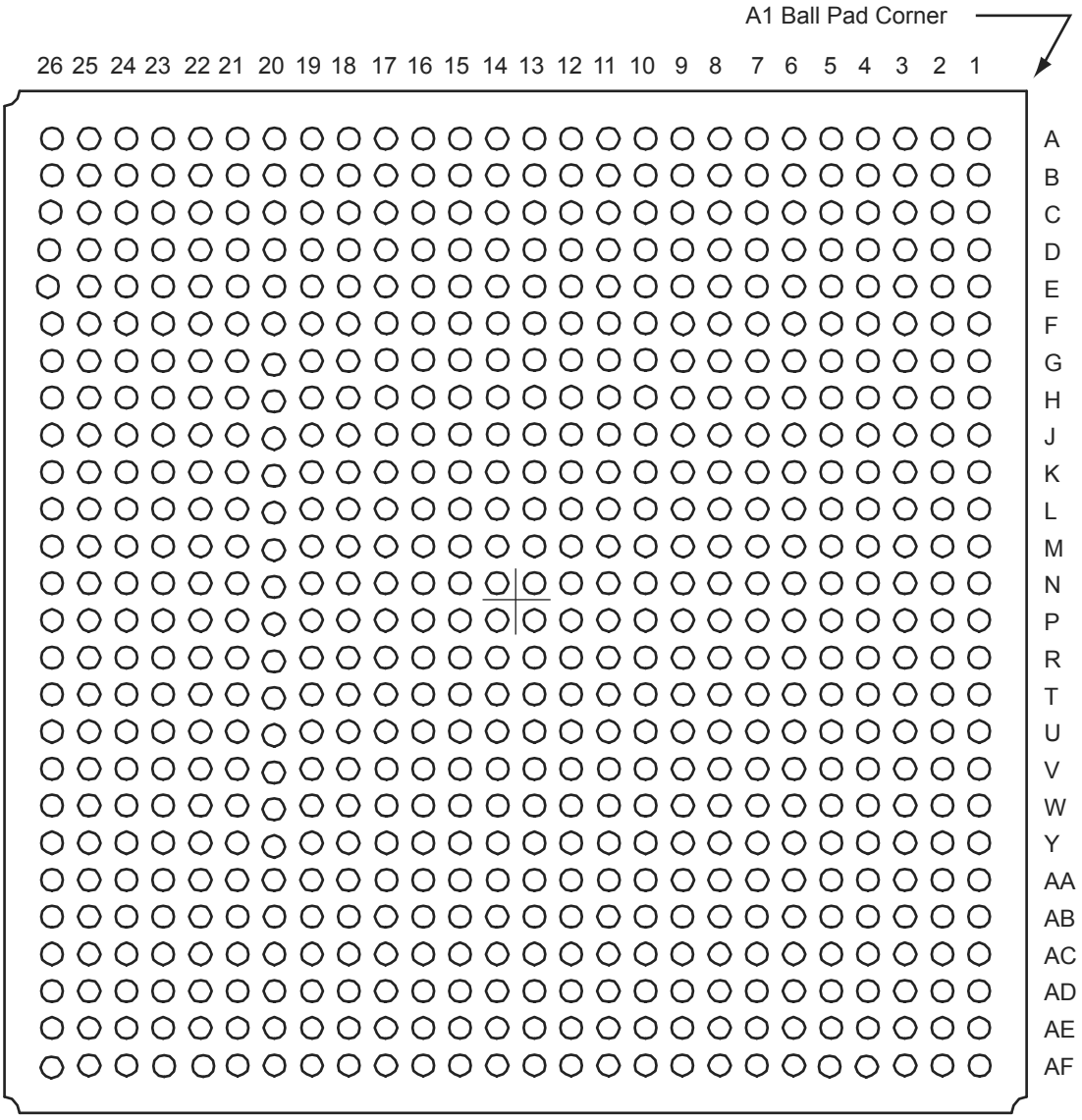
BG729	
AX1000 Function	**Pin Number**
VCCIB4	W17
VCCIB4	W18
VCCIB5	AE4
VCCIB5	AF4
VCCIB5	AG4
VCCIB5	V12
VCCIB5	V13
VCCIB5	W10
VCCIB5	W11
VCCIB5	W12
VCCIB6	AD1
VCCIB6	AD2
VCCIB6	AD3
VCCIB6	R10
VCCIB6	T10
VCCIB6	T9
VCCIB6	U9
VCCIB6	V9
VCCIB7	D1
VCCIB7	D2
VCCIB7	D3
VCCIB7	K9
VCCIB7	L9
VCCIB7	M10
VCCIB7	M9
VCCIB7	N10
VCOMPLA	B13
VCOMPLB	A14
VCOMPLC	A15
VCOMPLD	J15
VCOMPLE	AG15
VCOMPLF	W15
VCOMPLG	AC14
VCOMPLH	W13
VPUMP	D24

FG256-Pin FBGA	
AX125 Function	**Pin Number**
Bank 6	
IO60NB6F6	L4
IO60PB6F6	M4
IO61NB6F6	L3
IO61PB6F6	M3
IO63NB6F6	P2
IO63PB6F6	N2
IO64NB6F6	J4
IO64PB6F6	K4
IO65NB6F6	N1
IO65PB6F6	P1
IO67NB6F6	L2
IO67PB6F6	M2
IO69NB6F6	L1
IO69PB6F6	M1
IO70NB6F6	J3
IO70PB6F6	K3
IO71NB6F6	J2
IO71PB6F6	K2
Bank 7	
IO72NB7F7	J1
IO72PB7F7	K1
IO73NB7F7	G2
IO73PB7F7	H2
IO74NB7F7	G3
IO74PB7F7	H3
IO75NB7F7	E1
IO75PB7F7	F1
IO76NB7F7	G1
IO77NB7F7	E2
IO77PB7F7	F2
IO78NB7F7	G4
IO78PB7F7	H4
IO79NB7F7	C1
IO79PB7F7	D1

FG256-Pin FBGA	
AX125 Function	**Pin Number**
IO81NB7F7	C2
IO81PB7F7	B1
IO82NB7F7	D2
IO82PB7F7	D3
IO83NB7F7	E3
IO83PB7F7	F3
Dedicated I/O	
VCCDA	E4
GND	A1
GND	A16
GND	B15
GND	B2
GND	D15
GND	E12
GND	E5
GND	F11
GND	F6
GND	G10
GND	G7
GND	G8
GND	G9
GND	H10
GND	H7
GND	H8
GND	H9
GND	J10
GND	J7
GND	J8
GND	J9
GND	K10
GND	K7
GND	K8
GND	K9
GND	L11
GND	L6

FG256-Pin FBGA	
AX125 Function	**Pin Number**
GND	M12
GND	M5
GND	P13
GND	P3
GND	R15
GND	R2
GND	T1
GND	T16
GND/LP	D4
NC	A11
NC	R11
NC	R5
PRA	D8
PRB	C8
PRC	N9
PRD	P9
TCK	D5
TDI	C6
TDO	C4
TMS	C3
TRST	C5
VCCA	D14
VCCA	F10
VCCA	F4
VCCA	F7
VCCA	F8
VCCA	F9
VCCA	G11
VCCA	G6
VCCA	H11
VCCA	H6
VCCA	J11
VCCA	J6
VCCA	K11
VCCA	K6

FG676



Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

FG676	
AX500 Function	**Pin Number**
VCCIB3	T19
VCCIB3	U19
VCCIB3	U20
VCCIB3	V19
VCCIB3	V20
VCCIB3	W20
VCCIB4	W14
VCCIB4	W15
VCCIB4	W16
VCCIB4	W17
VCCIB4	W18
VCCIB4	Y17
VCCIB4	Y18
VCCIB4	Y19
VCCIB5	W10
VCCIB5	W11
VCCIB5	W12
VCCIB5	W13
VCCIB5	W9
VCCIB5	Y10
VCCIB5	Y8
VCCIB5	Y9
VCCIB6	P8
VCCIB6	R8
VCCIB6	T8
VCCIB6	U7
VCCIB6	U8
VCCIB6	V7
VCCIB6	V8
VCCIB6	W7
VCCIB7	H7
VCCIB7	J7
VCCIB7	J8
VCCIB7	K7
VCCIB7	K8

FG676	
AX500 Function	**Pin Number**
VCCIB7	L8
VCCIB7	M8
VCCIB7	N8
VCCPLA	E12
VCCPLB	F13
VCCPLC	E15
VCCPLD	G14
VCCPLE	AF15
VCCPLF	AA14
VCCPLG	AF12
VCCPLH	AB13
VCOMPLA	D12
VCOMPLB	G13
VCOMPLC	D15
VCOMPLD	F14
VCOMPLE	AD15
VCOMPLF	AB14
VCOMPLG	AD12
VCOMPLH	Y13
VPUMP	E22

FG896	
AX1000 Function	**Pin Number**
VCCIB2	L22
VCCIB2	M21
VCCIB2	M22
VCCIB2	N21
VCCIB2	P21
VCCIB2	R21
VCCIB3	AA22
VCCIB3	AH29
VCCIB3	AH30
VCCIB3	T21
VCCIB3	U21
VCCIB3	V21
VCCIB3	W21
VCCIB3	W22
VCCIB3	Y21
VCCIB3	Y22
VCCIB4	AA16
VCCIB4	AA17
VCCIB4	AA18
VCCIB4	AA19
VCCIB4	AA20
VCCIB4	AB19
VCCIB4	AB20
VCCIB4	AB21
VCCIB4	AJ28
VCCIB4	AK28
VCCIB5	AA11
VCCIB5	AA12
VCCIB5	AA13
VCCIB5	AA14
VCCIB5	AA15
VCCIB5	AB10
VCCIB5	AB11
VCCIB5	AB12
VCCIB5	AJ3

FG896	
AX1000 Function	**Pin Number**
VCCIB5	AK3
VCCIB6	AA9
VCCIB6	AH1
VCCIB6	AH2
VCCIB6	T10
VCCIB6	U10
VCCIB6	V10
VCCIB6	W10
VCCIB6	W9
VCCIB6	Y10
VCCIB6	Y9
VCCIB7	C1
VCCIB7	C2
VCCIB7	K9
VCCIB7	L10
VCCIB7	L9
VCCIB7	M10
VCCIB7	M9
VCCIB7	N10
VCCIB7	P10
VCCIB7	R10
VCOMPLA	F14
VCOMPLB	J15
VCOMPLC	F17
VCOMPLD	H16
VCOMPLE	AF17
VCOMPLF	AD16
VCOMPLG	AF14
VCOMPLH	AB15
VPUMP	G24

FG1152	
AX2000 Function	Pin Number
Bank 0	
IO00NB0F0	D6
IO00PB0F0	C6
IO01NB0F0	H10
IO01PB0F0	H9
IO02NB0F0	F8
IO02PB0F0	G8
IO03NB0F0	A6
IO03PB0F0	B6
IO04NB0F0	C7
IO04PB0F0	D7
IO05NB0F0	K10
IO05PB0F0	J10
IO06NB0F0	F9
IO06PB0F0	G9
IO07NB0F0	F10
IO07PB0F0	G10
IO08NB0F0	E9
IO08PB0F0	E8
IO09NB0F0	J11
IO09PB0F0	K11
IO10NB0F0	C8
IO10PB0F0	D8
IO11NB0F0	K12
IO11PB0F0	J12
IO12NB0F1	G11
IO12PB0F1	H11
IO13NB0F1	G12
IO13PB0F1	H12
IO14NB0F1	A7
IO14PB0F1	B7
IO15NB0F1	H13
IO15PB0F1	J13
IO16NB0F1	C9
IO16PB0F1	D9

FG1152	
AX2000 Function	Pin Number
IO17NB0F1	F12
IO17PB0F1	F11
IO18NB0F1	E11
IO18PB0F1	E10
IO19NB0F1	F13
IO19PB0F1	G13
IO20NB0F1	A10
IO20PB0F1	A9
IO21NB0F1	K14
IO21PB0F1	K13
IO22NB0F2	B11
IO22PB0F2	B10
IO23NB0F2	C12
IO23PB0F2	C11
IO24NB0F2	A12
IO24PB0F2	A11
IO25NB0F2	H14
IO25PB0F2	J14
IO26NB0F2	D13
IO26PB0F2	D12
IO27NB0F2	F14
IO27PB0F2	G14
IO28NB0F2	E14
IO28PB0F2	E13
IO29NB0F2	B13
IO29PB0F2	B12
IO30NB0F2	C14
IO30PB0F2	C13
IO31NB0F2	H15
IO31PB0F2	J15
IO32NB0F2	A14
IO32PB0F2	B14
IO33NB0F2	K15
IO33PB0F2	L15
IO34NB0F3	D15

FG1152	
AX2000 Function	Pin Number
IO34PB0F3	D14
IO35NB0F3	A15
IO35PB0F3	B15
IO36NB0F3	B16
IO36PB0F3	A16
IO37NB0F3	G16
IO37PB0F3	G15
IO38NB0F3	D16
IO38PB0F3	C16
IO39NB0F3	K16
IO39PB0F3	L16
IO40NB0F3	D17
IO40PB0F3	C17
IO41NB0F3/HCLKAN	E16
IO41PB0F3/HCLKAP	F16
IO42NB0F3/HCLKBN	G17
IO42PB0F3/HCLKBP	F17
Bank 1	
IO43NB1F4/HCLKCN	G19
IO43PB1F4/HCLKCP	G18
IO44NB1F4/HCLKDN	E19
IO44PB1F4/HCLKDP	F19
IO45NB1F4	C18
IO45PB1F4	D18
IO46NB1F4	A18
IO46PB1F4	B18
IO47NB1F4	K19
IO47PB1F4	L19
IO48NB1F4	C19
IO48PB1F4	D19
IO49NB1F4	K20
IO49PB1F4	L20
IO50NB1F4	A19
IO50PB1F4	B19
IO51NB1F4	H20

CQ352	
AX250 Function	**Pin Number**
VCCDA	346
VCCIB0	321
VCCIB0	333
VCCIB0	344
VCCIB1	273
VCCIB1	285
VCCIB1	297
VCCIB2	227
VCCIB2	239
VCCIB2	245
VCCIB2	257
VCCIB3	185
VCCIB3	197
VCCIB3	203
VCCIB3	215
VCCIB4	144
VCCIB4	156
VCCIB4	168
VCCIB5	96
VCCIB5	108
VCCIB5	120
VCCIB6	50
VCCIB6	62
VCCIB6	68
VCCIB6	80
VCCIB7	8
VCCIB7	20
VCCIB7	26
VCCIB7	38
VCCPLA	317
VCCPLB	315
VCCPLC	303
VCCPLD	301
VCCPLE	140
VCCPLF	138

CQ352	
AX250 Function	**Pin Number**
VCCPLG	126
VCCPLH	124
VCOMPLA	318
VCOMPLB	316
VCOMPLC	304
VCOMPLD	302
VCOMPLE	141
VCOMPLF	139
VCOMPLG	127
VCOMPLH	125
VPUMP	267

CG624	
AX1000 Function	Pin Number
Bank 0	
IO00NB0F0	F8
IO00PB0F0	F7
IO02NB0F0	G7
IO02PB0F0	G6
IO04NB0F0	E9
IO04PB0F0	D8
IO06NB0F0	G9
IO06PB0F0	G8
IO07PB0F0	B6
IO08NB0F0	F10
IO08PB0F0	F9
IO09PB0F0	C7
IO10NB0F0	H8
IO10PB0F0	H7
IO11NB0F0	D10
IO11PB0F0	D9
IO12NB0F1	B5
IO12PB0F1	B4
IO13NB0F1	A7
IO13PB0F1	A6
IO14NB0F1	C9
IO14PB0F1	C8
IO15PB0F1	B7
IO16NB0F1	A5
IO16PB0F1	A4
IO17NB0F1	A9
IO17PB0F1	B9
IO18NB0F1	D12
IO18PB0F1	D11
IO20NB0F1	B11
IO20PB0F1	B10
IO21NB0F1	A11
IO21PB0F1	A10
IO22NB0F2	H10
IO22PB0F2	H9

CG624	
AX1000 Function	Pin Number
IO23NB0F2	E11
IO23PB0F2	F11
IO24NB0F2	D7
IO24PB0F2	E7
IO25PB0F2	B12
IO26NB0F2	H11
IO26PB0F2	G11
IO27NB0F2	C11
IO27PB0F2	B8
IO28NB0F2	J13
IO28PB0F2	K13
IO29NB0F2	J8
IO29PB0F2	J7
IO30NB0F2/HCLKAN	G13
IO30PB0F2/HCLKAP	G12
IO31NB0F2/HCLKBN	C13
IO31PB0F2/HCLKBP	C12
Bank 1	
IO32NB1F3/HCLKCN	G15
IO32PB1F3/HCLKCP	G14
IO33NB1F3/HCLKDN	B14
IO33PB1F3/HCLKDP	B13
IO34NB1F3	G16
IO34PB1F3	H16
IO35NB1F3	C17
IO35PB1F3	B18
IO36NB1F3	H18
IO36PB1F3	H15
IO37NB1F3	H13
IO38NB1F3	E15
IO38PB1F3	F15
IO39NB1F3	D14
IO39PB1F3	C14
IO40NB1F3	D16
IO40PB1F3	D15
IO41NB1F4	F16

CG624	
AX1000 Function	Pin Number
IO42NB1F4	G21
IO42PB1F4	G20
IO43NB1F4	A16
IO43PB1F4	A15
IO44NB1F4	A20
IO44PB1F4	A19
IO45NB1F4	B17
IO45PB1F4	B16
IO46NB1F4	G17
IO46PB1F4	H17
IO47NB1F4	A17
IO48NB1F4	C19
IO48PB1F4	C18
IO49NB1F4	B20
IO49PB1F4	B19
IO50NB1F4	H20
IO50PB1F4	H19
IO51NB1F4	A22
IO51PB1F4	A21
IO52NB1F4	C21
IO52PB1F4	C20
IO53NB1F4	B22
IO53PB1F4	B21
IO54NB1F5	J18
IO54PB1F5	J19
IO55NB1F5	D18
IO55PB1F5	D17
IO56NB1F5	F20
IO56PB1F5	F19
IO58NB1F5	E17
IO58PB1F5	F17
IO60NB1F5	D20
IO60PB1F5	D19
IO62NB1F5	E18
IO62PB1F5	F18
IO63NB1F5	G19

Revision	Changes	Page
Revision 8 (continued)	The following changes were made in the "FG676"(AX500) section: AE2, AE25 Change from NC to GND. AF2, AF25 Changed from GND to NC AB4, AF24, C1, C26 Changed from V_{CCDA} to V_{CCA} AD15 Change from V_{CCDA} to V_{COMPLE} AD17 Changed from V_{COMPLE} to V_{CCDA}	3-37
	In the "FG896" (AX2000) section, the AK28 changed from VCCIB5 to VCCIB4.	3-52
	The "CQ352" and "CG624" sections are new.	3-98, 3-115
Revision 7 (Advance v1.6)	All I/O FIFO capability was removed.	n/a
	Table 1 was updated.	i
	Figure 1-9 was updated.	1-7
	Figure 2-5 was updated.	2-16
	The "Using an I/O Register" section was updated.	2-16
	The AX250 and AX1000 descriptions were added to the "FG484"section.	3-21
Revision 6 (Advance v1.5)	Table 2-3 was updated.	2-2
	Figure 2-1 was updated.	2-8
	Figure 2-48 was updated.	2-75
	Figure 2-52 was updated.	2-82
Revision 5 (Advance v1.4)	In the "PQ208" table, pin 196 was missing, but it has been added in this version with a function of GND.	3-84
	The following pins in the "FG484" table for AX500 were changed: Pin G7 is GND/LP Pins AB8, C10, C11, C14, AB16 are NC.	3-21
	The "FG676" table was updated.	3-37
Revision 4 (Advance v1.3)	The "Device Resources" section was updated for the CS180.	ii
	The "Programmable Interconnect Element" and Figure 1-2 are new.	1-1 and 1-2
	The "CS180" table is new.	3-1
	The "PQ208" tables for the AX500 were updated. The following pins were not defined in the previous version: GND 21 IO106PB5F10/CLKHP 71 GND 136	3-84
Revision 3 (Advance v1.2)	Table 1, "Ordering Information", "Device Resources", and the Product Plan table were updated.	i, ii
	The following figures and tables were updated: Figure 1-3 Figure 1-8 (new) Table 2-3 Figure 2-2 Table 2-8 Figure 2-11	 1-2 1-6 2-2 2-9 2-12 2-23
	The "Design Environment" section was updated.	1-7
	The "Package Thermal Characteristics" was updated.	2-6